**Overview** 

## HP EliteBook 1040 14" G9 Notebook PC



### Left

- 1. Internal Microphones (2)
- 2. Ambient Light Sensor (Optional)
- 3. Webcam
- 4. Camera Shutter
- 5 IR Camera (Optional)
- 6. IR Camera LEDs (Optional)
- 7. Glass Clickpad
- 1. SuperSpeed USB 20Gbps is not available with Thunderbolt  $^{\text{TM}}$  4.

- 8. Smartcard Reader (Optional)
- 9. LED Indicator
- **10.** Thunderbolt<sup>TM</sup> 4 with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort<sup>TM</sup> 1.4)<sup>1</sup>
- **11.** Thunderbolt<sup>TM</sup> 4 with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort<sup>TM</sup> 1.4)<sup>1</sup>
- **12.** SuperSpeed USB Type-A 5Gbps signaling rate (USB 3.2 Gen 1)
- 13. HDMI 2.0b Port (Cable not included)

## Overview



## Right

- 1. Power Button Key
- 2. Audio Combo Jack
- **3.** SuperSpeed USB Type-A 5Gbps signaling rate (Charging) **6.** (USB 3.2 Gen 1)
- 4. Nano Security Lock Slot (Lock sold separately)
- 5. SIM Card Slot (Optional)
  - Touch Fingerprint Sensor (Select models)

Overview

## At a Glance

- Preinstalled with Windows 11 versions or FreeDOS
- A new clamshell ultraslim design with precision-crafted magnesium chassis for a premium look and feel
- 12th Generation Intel® Core™ i5, i7 U series, up to ten-core
- New 16:10 aspect ratio screen reduces the need to scroll by showing more vertical content than 16:9
- New 5MP camera with HP Auto Frame allows you around a little without losing viewers' attention during video calls
- New DDR5 memory (up to 64GB) and PCI Gen4 SSDs provide fast access to your work.
- Choice of displays:

35.6 cm (14"?) diagonal AG WUXGA (1920x1200) LED-backlit, 250 nits, 45% NTSC, non-touch

35.6 cm (14"?) diagonal AG WUXGA (1920x1200) LED-backlit, 250 nits, 45% NTSC, touchscreen

35.6 cm (14"?) diagonal AG WUXGA (1920x1200) LED-backlit, 400 nits, 100% sRGB, non-touch with HP Eye Ease

35.6 cm (14"?) diagonal AG WUXGA (1920x1200) LED-backlit, 1000 nits, 100% sRGB, HP Sure View Reflect, non-touch with HP Ey Ease

- Redesigned keyboard layout to include easy use of discrete PgUp/Dn, End, and Home keys
- Choose from 38Wh or 51Wh battery options
- HP Wolf Security for Business creates a hardware-enforced, always-on, resilient defense
- Larger clickpad surface for easier, more intuitive input
- Connectivity with optional Intel® 5000 5G/WWAN available world-wide, and Thunderbolt<sup>™</sup> Docking (Dock sold separately)
- Undergoes MIL-STD 810H tests
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Designed to support all HP docking options including the HP Universal Dock G5

NOTE: See important legal disclosures for all listed specs in their respective features sections.



**Technical Specifications** 

## PRODUCT NAME

HP EliteBook 1040 14" G9 Notebook PC

## **OPERATING SYSTEMS**

**Preinstalled** Windows 11 Pro <sup>1</sup>

Windows 11 Pro Education <sup>1</sup>

Windows 11 Home - HP recommends Windows 11 Pro for Business<sup>1</sup>

Windows 11 Home Single Language - HP recommends Windows 11 Pro for Business<sup>1</sup> Windows 11 Pro (Windows 11 Enterprise available with a Volume Licensing Agreement) <sup>1</sup>

Windows 10 Pro (available through downgrade rights from Windows 11 Pro) 1,2

**FreeDOS** 

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See <a href="http://www.windows.com">http://www.windows.com</a>.
- 2. This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions wi require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

# **PROCESSORS**

Processor	Cores	Number	Number	Threads	L3 Cache	_	Turbo uency	Ba Frequ	se uency	Intel SIPP/vPro®
3,4,5,6,7	COLES	P-cores	E-cores	inicaus	LJ Cacile	P-	E-	P-	E-	Enterprise
			_ coics			cores	cores	cores	cores	
Intel® Core <sup>TM</sup> i7-	10	2	8	12	12MB	4.8	3.6	1.8	1.3	Χ
1265U						GHz	GHz	GHz	GHz	
Intel® Core <sup>TM</sup> i7-	10	2	8	12	12MB	4.7	3.5	1.7	1.2	
1255U						GHz	GHz	GHz	GHz	
Intel® Core <sup>TM</sup> i5-	10	2	8	12	12MB	4.4	3.3	1.2	1.2	Χ
1245U						GHz	GHz	GHz	GHz	
Intel® Core <sup>TM</sup> i5-	10	2	8	12	12MB	4.4	3.3	1.3	0.9	
1235U						GHz	GHz	GHz	GHz	

- 3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.
- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
- 5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See www.intel.com/technology/turboboost for more information.
- 6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on produconfigured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on <a href="http://www.support.hp.com">http://www.support.hp.com</a>.
- 7. Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired

### **Technical Specifications**

LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro® Essentials and Enterprise vary. See http://intel.com/vpro

## CHIPSET

Chipset is integrated with processor

## **GRAPHICS**

### Integrated

Intel® Iris® X? Graphics 8

### Supports

Support HD decode, DX12, HDMI 2.0b, HDCP 2.3 9

8. Intel® Iris® X? Graphics capabilities require system to be configured with Intel® Core<sup>TM</sup> i5 or i7 processors and dual channel memory. Intel® Iris® X? Graphics with Intel® Core<sup>TM</sup> i5 or 7 processors and single channel memory will only function as UHD graphics.

9. HDMI cable sold separately

## **DISPLAY**

### Non-Touch

35.6 cm (14") diagonal, WUXGA bent, anti-glare UWVA, 250 nits, 45%NTSC, time of flight sensor, with 5 MP+IR camera (1920 x 1200) 10,11

35.6 cm (14") diagonal, WUXGA bent, anti-glare UWVA, 250 nits, 45%NTSC, time of flight sensor, with 5 MP+IR camera for WWAN (1920 x 1200) 10,11

35.56 cm (14") diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP+PSR, 400 nits, 100% sRGB, Low Power, Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR Camera (1920 x 1200) with HP Eye Ease 10,11

35.56 cm (14") diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP+PSR, 400 nits, 100% sRGB, Low Power, Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR Camera for WWAN (1920 x 1200) with HP Eve Ease 10,11

35.56 cm (14") diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR camera (1920 x 1200) with HP Eye Ease 10,11,12,13

35.56 cm (14") diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR camera for WWAN (197 x 1200) with HP Eye Ease 10,11,12,13

### **Touch**

35.6 cm (14") diagonal, WUXGA bent, anti-glare UWVA, 250 nits, 45%NTSC, with 5 MP+IR camera, time of flight sensor Touch on Panel (1920 x 1200) 10,11,13

35.6 cm (14") diagonal, WUXGA bent, anti-glare UWVA, 250 nits, 45%NTSC, with 5 MP+IR camera, time of flight sensor for WWAN Touch on Panel (1920 x 1200) 9,10,12

### DisplayPort<sup>TM</sup> 1.2

HDMI 2.0 Support resolution up to 4K @60 Hz 9

### **Displays support**

Supports dual display through the dock

## Display Size (diagonal)

14

35.56 cm (14")

9. HDMI cable sold separately

### **Technical Specifications**

- 10. HD content required to view HD images.
- 11. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
- 12. HP Sure View Reflect integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.
- 13. Actual brightness will be lower with touchscreen or HP Sure View.

# **DOCKING (Sold Separately)**

Docking station model #1 HP Thunderbolt Dock G2
Docking station model #2 HP USB-C Dock G5

**Docking station model #3** HP USB-C/A Universal Dock G2

For additional aftermarket options and docking specs please see page 41.

# STORAGE AND DRIVES

### **Primary M.2 Storage**

2 TB PCIe® Gen4x4 NVMe<sup>TM</sup> M.2 SSD TLC <sup>14</sup>
1 TB PCIe® Gen4x4 NVMe<sup>TM</sup> M.2 SSD TLC <sup>14</sup>
512 GB PCIe® Gen4x4 NVMe<sup>TM</sup> M.2 SSD TLC <sup>14</sup>
512 GB PCIe® Gen4x4 NVMe<sup>TM</sup> SED TLC OPAL2 <sup>14</sup>
512 GB PCIe® NVMe<sup>TM</sup> Value M.2 SSD <sup>14</sup>
256 GB PCIe® Gen4x4 NVMe<sup>TM</sup> M.2 SSD TLC <sup>14</sup>
256 GB PCIe® Gen4x4 NVMe<sup>TM</sup> SED TLC OPAL2 <sup>14</sup>
256 GB PCIe® NVMe<sup>TM</sup> Value M.2 SSD <sup>14</sup>

14. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 an 11) is reserved for system recovery software.

## **MEMORY**

## **Technical Specifications**

### **Maximum Memory**

64GB DDR5-4800 15

### Memory

64GB DDR5-4800 (2x32GB) <sup>15</sup> 32GB DDR5-4800 (2x16GB) <sup>15</sup> 32GB DDR5-4800 (1x32GB) <sup>15</sup> 16GB DDR5-4800 (2x8GB) <sup>15</sup> 16GB DDR5-4800 (1x16GB) <sup>15</sup> 8GB DDR5-4800 (1x8GB) <sup>15</sup>

### **Memory Slots**

2 SODIMM DDR5 SODIMMS, system runs at 4800 Supports Dual Channel Memory

15. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensurcompatibility. If you mix memory speeds, the system will perform at the lower memory speed.

# **NETWORKING/COMMUNICATIONS**

#### WI AN

Intel® AX211 Wi-Fi6E + Bluetooth® 5.2 M.2 160MHz CNVi Word-Wide WLAN vPro <sup>16,17,18</sup> Intel® AX211 Wi-Fi6E + Bluetooth® 5.2 M.2 160MHz CNVi Word-Wide WLAN non-vPro <sup>16,18</sup>

### WWAN

Intel® 5000 5G Solution WWAN <sup>19,20</sup>
Intel® XMM 7560 R+ LTE-Advanced Pro WWAN (Cat 16) <sup>19</sup>

### NFC

Near Field Communications Controller <sup>21</sup>
HP Module with NXP NFC Controller NPC300 I2C NCI

### Miracast

Native Miracast Support 22

16. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

17. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

18. For full Intel® vPro<sup>TM</sup> functionality, Windows, a vPro supported processor, vPro enabled chipset, vPro enabled WLAN card and discrete TPM 2.0 are required. See https://www.intel.com/content/www/us/en/architecture-and-technology/vpro/vpro-platforn general html

19. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, networ conditions, and other factors. 4G LTE not available on all products, in all regions.

20. Intel 5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. Backwards compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select platforms and select countries, where carrier supported.

21. Sold separately or as an optional feature.

22. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.



## **Technical Specifications**

### **AUDIO/MULTIMEDIA**

### **Audio**

Audio by Bang & Olufsen 2 Integrated stereo speakers Discrete Amplifiers Integrated dual array microphone

### **Speaker Power**

2W/4ohm Per speaker

#### Camera

5 MP+IR camera 21

### Sensors

ALS (ambient light sensor) Magnetometer Hall Sensor Gyro Accelerometer HP Tamper Lock <sup>23</sup>

- 21. Sold separately or as an optional feature.
- 23. HP Tamper Lock must be enabled by the customer or your administrator.

# **KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS**

### Keyboard

HP Premium Keyboard, spill resistant, Backlit keyboard and DuraKeys

### **Pointing Device**

Clickpad with multi-touch gesture support, taps enabled as default Microsoft Precision Touchpad Default Gestures Support

### **Function Keys**

ESC: system information

F1 - Display Switching

F2 - Blank or Privacy

F3 - Brightness Down

F4 - Brightness Up

F5 - Audio Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Blank or Backlit Toggle

F10 - Insert

F11 - Airplane Mode

F12 - HP Command Center

home

end

Power Button (with LED)

Delete

### **Hidden Function Keys**

### **Technical Specifications**

Fn+R - Break Fn+S - Sys Rq Fn+C - Scroll Lock

### SOFTWARE AND SECURITY

### Software

**HP Quick Touch** HP Quick Drop 24 HP Easy Clean<sup>25</sup> **HP PC Hardware Diagnostics Windows** myHP Tile App <sup>26</sup> HP Smart Support 27 **HP Connection Optimizer HP Hotkey Support** HP Support Assistant 28 **HP Notifications** 

**HP Privacy Settings** 

**HP Power Manager** 

Buy Microsoft Office (Sold separately)

### **Manageability Features**

HP Image Assistant Gen5 (download) HP Manageability Integration Kit (download) 29 HP Client Management Script Library (download) **HP Driver Packs (download)** HP Cloud Recovery 30 **HP Client Catalog (download)** 

### **Security Management**

### HP Wolf Security of Business 31 includes:

HP Sure Click 32 HP Sure Sense 33 HP Sure Run Gen5 34 HP Sure Recover Gen5 35 HP Sure Start Gen7 36 **HP Tamper Lock** HP Sure Admin 37 HP Client Security Manager Gen7 38

### BIOS

HP BIOSphere Gen6 39 HP Secure Erase 40 Absolute Persistence Module 41 **HP DriveLock & Automatic DriveLock BIOS Update via Network** HP Wake on WLAN HP Fingerprint Sensor 42 Secured-Core PC Enable 43 TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified)

### Security **TPM**

## **Technical Specifications**

Model: Infineon SLB9672VU2.0

Version: 15.21 Revision: TPM 2.0

FIPS 140-2 Compliant: Yes

### **Smartcard Reader**

Model number: Alcor AU9560 FIPS 201 Compliant: Yes

### **IPv6 Support**

Yes

### **FirstNet Certified**

Yes

### Is the BIOS on this notebook ISO/IEC 19678:2015 (formerly NIST 800-147) compliant?: Yes

UEFI version: 2.7 Class: Class 3

24. HP Quick Drop requires Internet access and Windows 10 or higher PC preinstalled with HP QuickDrop app and either an Androic device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.

25. HP Easy Clean requires Windows 10 RS3 and higher and will disable the keyboard, touchscreen, and clickpad only. Ports are no disabled. See user guide for cleaning instructions.

26. Some Tile features require optional subscription to Tile Premium. Tile application for Windows 10 available for download from the Windows Store. Mobile phone app available for download from App Store and Google Play. Requires iOS 11 and greater or Android 6.0 and greater see https://support.thetileapp.com/hc/en-us/articles/200424778 for more information. Tile will function as long as the PC has battery power.

27. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or i can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.

28. HP Support Assistance requires Windows and Internet Access.

29. HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html. 30. HP Cloud Recovery is available for Z by HP, HP Elite and Pro desktops and laptops PCs with Intel® or AMD processors and

requires an open, wired network connection. Note: You must back up important files, data, photos, videos, etc. before use to avoic loss of data. Detail please refer to: https://support.hp.com/us-en/document/c05115630.

31. HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features and OS requirement..

32. HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A\_SureClick for complete details.

33. HP Sure Sense is available on select HP PCs with Windows 10 Pro, Windows 10 Enterprise, Windows 11 Pro, or Windows 11 Enterprise OS.

34. HP Sure Run Gen5 is available on select HP PCs and requires Windows 10 and higher.

35. HP Sure Recover Gen5 with Embedded Reimaging is an optional feature which requires Windows 10 and higher must be configured at purchase. You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module.

36. HP Sure Start Gen7 is available on select HP PCs and requires Windows 10 and higher.

37. HP Sure Admin requires Windows 10 or higher, HP BIOS, HP Manageability Integration Kit from

http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.

38. HP Client Security Manager Gen7 requires Windows and is available on the select HP Elite and Pro PCs.

39. HP BIOSphere Gen6 features may vary depending on the platform and configuration.

40. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane<sup>TM</sup>.

41. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, che with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: https://www.absolute.com/about/legal/agreements/absolute/.

42. HP Fingerprint sensor is an optional feature that must be configured at purchase.

43. Secured-Core PC Enable requires an Intel® vPro®, AMD Ryzen<sup>TM</sup> Pro processor or Qualcomm® processor with SD850 or higher and requires 8 GB or more system memory. Secured-core PC is enabled from the factory.

## **Technical Specifications**

### **POWER**

### **Power Supply**

HP Smart 65 W USB Type-C adapter <sup>44</sup> HP Smart 65 W Slim USB Type-C adapter <sup>44</sup> HP Smart 45 W USB Type-C adapter <sup>44</sup>

### **Battery**

HP Long Life 3-cell, 38 Wh Polymer <sup>45,46</sup> HP Long Life 3-cell, 51 Wh Polymer <sup>45,46</sup> Compliant with UL 1642 Standard

### **Power Cord**

3-wire plug - 1m 2-wire plug - 1m

### **Battery Life**

Up to 13 hours 45 minutes (51 Whr battery) <sup>47</sup> Up to 10 hours (38 Whr battery) <sup>47</sup>

- 44. Availability may vary by country.
- 45. Battery is internal and not replaceable by customer. Serviceable by warranty.

46. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.
47. MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See <a href="http://www.bapco.com">http://www.bapco.com</a> for additional details.

### **WEIGHTS & DIMENSIONS**

Product Weight- 38 Whr <sup>48</sup>

Starting at 2.56 lb Starting at 1.16 kg

### Product Dimensions (W x D x H)

12.41 x 8.83 x 0.76 in 31.52 x 22.431 x 1.931 cm

48. Weight will vary by configuration. Does not include power adapter.

# PORTS/SLOTS

## **Technical Specifications**

2 Thunderbolt<sup>TM</sup> 4 with USB4 Type-C<sup>®</sup> 40Gbps signaling rate (USB Power Delivery, DisplayPort<sup>TM</sup> 1.4) <sup>49</sup>

2 Super Speed USB Type-A 5Gbps signaling rate (1 charging) (USB 3.2 Gen 1)

1 HDMI 2.0 9

1 Headphone/microphone combo jack

1 Nano Security Lock Slot (Lock sold separately)

1 Smartcard reader (Optional)

1 nano SIM card slot

9. HDMI cable sold separately

49. SuperSpeed USB 20Gbps is not available with Thunderbolt<sup>TM</sup> 4.

## SERVICE AND SUPPORT

1-year warranty and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for HP Long Life batteries which will follow the one or three year warranty of the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.

50. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

## SYSTEM UNIT

Stand-Alone Power Requirements Type-C Adapter

(AC Power)

Nominal Operating Voltage AC 20V

**Average Operating Power** 

Integrated graphics Yes
Discrete Graphics N/A

Max Operating Power UMA<65W

**Temperature** 

Operating 32° to 95° F (0° to 35° C)

Non-operating 41° to 95° F (5° to 35° C) (writing optical)

**Relative Humidity** 

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Shock

Operating 40 G, 2 ms, half-sine Non-operating 200 G, 2 ms, half-sine

**Random Vibration** 

### **Technical Specifications**

Operating 0.75 grams Non-operating 1.50 grams

**Altitude (unpressurized)** 

Operating -50 to 10,000 ft (-15.24 to 3,048 m) Non-operating -50 to 40,000 ft (-15.24 to 12,192 m)

**Planned Industry Standard** 

**Certifications** 

Regulatory Model Number HSN-I45C-4

UL Yes
CSA Yes
FCC Compliance Yes
ENERGY STAR® Certified<sup>51</sup>

EPEAT® Gold in the United States<sup>52</sup>

**ICES** Yes Australia / Yes NZ A-Tick Compliance Yes CCC Yes Japan VCCI Compliance Yes KC Yes **BSMI** Yes **CE Marking Compliance** Yes **BNCI or BELUS** Yes CIT Yes **GOST** Yes Saudi Arabian Compliance (ICCP) Yes **SABS** Yes

- 51. Configurations of the HP EliteBook 1040 14" G9 Notebook PC that are ENERGY STAR® qualified are identified as HP EliteBook 1040 14" G9 Notebook PC ENERGY STAR on HP websites and on http://www.energystar.gov.
- 52. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit http://www.epeat.net for more information.

# **DISPLAYS**

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

1. Actual brightness will be lower with touchscreen or HP Sure View.

## **Technical Specifications**

14.0 in WUXGA (1920 x 1200) Anti-Glare UWVA LED NTSC NB2X 250 eDP 1.2 w/o PSR 45 bent LCD Panel 

 Outline Dimensions (W x H x D)
 307.590 x 199.550 (max)

 Active Area
 301.590 X 188.500 (typ)

Weight 300 (max)
Diagonal Size 14

**Thickness** 3.0 / 5.0 (max)

Interface eDP 1.2
Surface Treatment Anti-Glare
Touch Enabled No

Contrast Ratio1000:1(typ)Refresh Rate60 HzBrightness250 nits

Pixel Resolution - Format 1920 x 1200 (WUXGA)

BacklightWLEDPixel ResolutionRGBColor Gamut CoverageNTSC 45%Color Depth8 bits

Viewing Angle UWVA 89/89/89

Low Blue Light No

Power Consumption (W, EBL@ 2.20 (max) / 2.70 (max) 150nits max/ 200nits max)

14.0 in WUXGA (1920 x 1200) Anti-Glare UWVA LED NTSC NB2X 250 TOP eDP 1.2 w/o PSR 45 bent LCD Panel

 Outline Dimensions (W x H x D)
 307.590 x 199.550 (max)

 Active Area
 301.590 x 188.500 (typ)

Weight 300 (max)

Diagonal Size 14

Thickness 3.0 / 5.0 (max)
Interface eDP 1.2
Surface Treatment Anti-Glare
Touch Enabled Yes¹
Contrast Ratio 1000:1(typ)

Refresh Rate 60 Hz
Brightness 250 nits<sup>1</sup>

Pixel Resolution - Format 1920 x 1200 (WUXGA)

BacklightWLEDPixel ResolutionRGBColor Gamut CoverageNTSC 45%Color Depth8 bits

Viewing Angle UWVA 89/89/89

Low Blue Light No.

Power Consumption (W, EBL@ 2.10 (max) / 2.60 (max) 150nits max/ 200nits max)

## **Technical Specifications**

14.0 in WUXGA (1920 x 1200) Anti-Glare UWVA WLED+LBL sRGB NB2X 400 eDP 1.4+PSR2 Low-Power 100 bent LCD Panel 

 Outline Dimensions (W x H x D)
 307.590 x 199.550 (max)

 Active Area
 301.590 X 188.500 (typ)

Weight 210 (max)
Diagonal Size 14

**Thickness** 2.0 / 3.8 (max)

Interface eDP 1.4
Surface Treatment Anti-Glare
Touch Enabled No

Contrast Ratio1000:1(typ)Refresh Rate60 HzBrightness400 nits

Pixel Resolution - Format 1920 x 1200 (WUXGA)

BacklightWLEDPixel ResolutionRGBColor Gamut CoveragesRGB 100%Color Depth8 bits

Viewing Angle UWVA 89/89/89

Low Blue Light Yes

Power Consumption (W, EBL@ 1.29 (max) / 1.66 (max) 150nits max/ 200nits max)

14.0 in WUXGA (1920 x 1200) Anti-Glare UWVA WLED+LBL sRGB NB2Y 1000 eDP 1.3+PSR 100 PrivacyG4 Plus bent LCD Panel 

 Outline Dimensions (W x H x D)
 307.600 x 199.550 (typ)

 Active Area
 301.680 x 188.500 (typ)

Weight 238 (max)

Diagonal Size 14

Thickness 2.2 / 3.9 (max)
Interface eDP 1.3
Surface Treatment Anti-Glare

Touch Enabled No

Contrast Ratio1500:1(typ)Refresh Rate60 HzBrightness1000 nits

Pixel Resolution - Format 1920 x 1200 (WUXGA)

BacklightWLEDPixel ResolutionRGBColor Gamut CoveragesRGB 100%Color Depth8 bits

Viewing Angle UWVA 85/85/85

Low Blue Light Yes
Power Consumption (W, EBL@ N/A
150nits max/ 200nits max)

## **Technical Specifications**

## STORAGE AND DRIVES

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

SSD 256GB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 256GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 4000 MB/s ±20%

 Maximum Sequential Write
 2000 MB/s ±20%

 Logical Blocks
 500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** Pyrite 2.0; TRIM; L1.2

SSD 512GB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 512GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 6400 MB/s ±20%

 Maximum Sequential Write
 3500 MB/s ±20%

 Logical Blocks
 1,000,215,215

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

SSD 1TB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 1TB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 6400 MB/s ±20%

 Maximum Sequential Write
 5000 MB/s ±20%

 Logical Blocks
 2,000,409,264

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

## **Technical Specifications**

SSD 2TB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 2TB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 6400 MB/s ±20%

 Maximum Sequential Write
 5000 MB/s ±20%

 Logical Blocks
 4,000,797,360

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

256GB PCIe-4x4 2280 NVME Self Encrypted OPAL2 Three Layer Cell Solid State Drive

Form Factor M.2 2280
Capacity 256GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 4000 MB/s ±20%

 Maximum Sequential Write
 2000 MB/s ±20%

 Logical Blocks
 500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features TCG Opal 2.0; TRIM; L1.2

512GB PCIe-4x4 2280 NVME Form Fact
Self Encrypted OPAL2 Three
Layer Cell Solid State Drive
LAND To

Form Factor M.2 2280
Capacity 512GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 6400 MB/s ±20%

 Maximum Sequential Write
 3500 MB/s ±20%

 Logical Blocks
 1,000,215,215

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features TCG Opal 2.0; TRIM; L1.2

### **Technical Specifications**

SSD 256GB 2280 PCIe NVMe

Value

Form Factor M.2 2280
Capacity 256 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3X4

 Maximum Sequential Read
 1500 MB/s ±20%

 Maximum Sequential Write
 750 MB/s ±20%

 Logical Blocks
 500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** Pyrite 2.0; TRIM; L1.2

SSD 512GB 2280 PCIe NVMe

Value

Form Factor M.2 2280
Capacity 512 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3X4

 Maximum Sequential Read
 1500 MB/s ±20%

 Maximum Sequential Write
 750 MB/s ±20%

 Logical Blocks
 1,000,215,215

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

## **NETWORKING/COMMUNICATIONS**

Intel® AX211 Wi-Fi 6E + Bluetooth® 5.2 M.2 160MHz CNVi World-Wide WLAN vPro®1,5 Wireless LAN Standards

IEEE 802.11a
IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
IEEE 802.11ax
IEEE 802.11d

IEEE 802.11d IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r

IEEE 802.11v
Interoperability Wi-Fi certified

Frequency Band 
● 802.11b/g/n/ax 2.402 - 2.482 GHz

## **Technical Specifications**

802.11a/n/ac/ax

4.9 - 4.95 GHz (Japan)

5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz 5.955 - 6.415 GHz 6.435 - 6.515 GHz 6.535 - 6.875 GHz 6.895 - 7.115 GHz

**Data Rates** 

• 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: max 300Mbps802.11ac: 1733Mbps802.11ax: max 2.4Gbps

**Modulation** Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security<sup>2</sup> IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

IEEE 802.11 compliant roaming between access points

WPA2 certification WPA3 certification IEEE 802.11i WAPI

**Network Architecture** 

Models Roaming Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Output Power<sup>3</sup> 802.11b: +17dBm minimum

802.11g: +16dBm minimum 802.11a: +17dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum 802.11n HT40(2.4GHz): +13dBm minimum 802.11n HT20(5GHz): +14dBm minimum 802.11n HT40(5GHz): +13dBm minimum 802.11ac VHT80(5GHz): +10dBm minimum 802.11ac VHT160(5GHz): +10dBm minimum 802.11ax HE40(2.4GHz): +12dBm minimum 802.11ax HE80(5GHz): +10dBm minimum 802.11ax HE160(5GHz): +10dBm minimum

**Power Consumption** Transmit mode 2.0 W

Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated)

Connected Standby 10mW

Radio disabled 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity<sup>4</sup>** 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0(VHT80): -84dBm maximum

## **Technical Specifications**

802.11ac, MCS9(VHT80): -59dBm maximum 802.11ac, MCS9(VHT160): -58.5dBm maximum 802.11ax, MCS11(HE40): -57dBm maximum 802.11ax, MCS11(HE80): -54dBm maximum 802.11ax, MCS11(HE160): -53.5dBm maximum

**Antenna type** High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** 1. Type 2230: 2.3 x 22.0 x 30.0 mm

**Weight** 1. Type 2230: 2.8g

**Operating Voltage** 3.3v +/- 9%

**Temperature Operating** 14° to 158° F (-10° to 70° C)

**Non-operating** -40° to 176° F (-40° to 80° C)

**Humidity Operating** 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

**Altitude Operating** 0 to 10,000 ft (3,048 m)

**Non-operating** 0 to 50,000 ft (15,240 m)

**LED Activity** LED Amber - Radio OFF; LED OFF - Radio ON

### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2/5.0/5.1/5.2 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy : 0~79 (1 MHz/CH)
Channels BLE : 0~39 (2 MHz/CH)

**Data Rates and**Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps **Throughput**BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 9.5 dBm for BR and EDR.

**Power Consumption** Peak (Tx): 330 mW

Peak (Rx): 230 mW

Selective Suspend: 17 mW

**Bluetooth Software** 

Supported Link Topology Microsoft Windows Bluetooth Software

**Power Management** Microsoft Windows ACPI, and USB Bus Support **Certifications** FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management Certifications

ETS 300 328, ETS 300 826

Low Voltage Directive IEC950

UL, CSA, and CE Mark

**Bluetooth Profiles** 

BT4.1-ESR 5/6/7 Compliance

**Supported**LE Link Layer Ping
LE Dual Mode

LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

## **Technical Specifications**

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full

LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2

Headset Profile (HSP)

Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

BT5.2

ESR9/10 Compliance

**LE Advertisement Extensions** 

Channel Selection Algo

Limited High Duty Cycle Non-Connectable Advertising

2Mbps LE

LE Long Range

- 1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.
- 2. Check latest software/driver release for updates on supported security features.
- 3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
- 5. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Require a wireless router, sold separately, that supports 80MHz and higher channels.

Intel® AX211 Wi-Fi 6E + Bluetooth® 5.2 M.2 160MHz CNVi World-Wide WLAN non-vPro®1,5 **Wireless LAN Standards** 

IEEE 802.11a

IEEE 802.11b

IEEE 802.11g

IEEE 802.11n IEEE 802.11ac

IEEE 802.11ax

IEEE 002.11d/

IEEE 802.11d

IEEE 802.11e

IEEE 802.11h

IEEE 802.11i IEEE 802.11k

IEEE 802.11r

IEEE 802.11v

Interoperability

**Frequency Band** 

Wi-Fi certified

802.11b/g/n/ax

2.402 - 2.482 GHz

802.11a/n/ac/ax

4.9 - 4.95 GHz (Japan)

5.15 - 5.25 GHz

5.25 - 5.35 GHz

5.47 - 5.725 GHz

5.825 - 5.850 GHz

5.955 - 6.415 GHz

6.435 - 6.515 GHz

6.535 - 6.875 GHz

## **Technical Specifications**

6.895 - 7.115 GHz

• 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: max 300Mbps802.11ac : 1733Mbps802.11ax : max 2.4Gbps

**Modulation** Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security<sup>2</sup> IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification WPA3 certification IEEE 802.11i WAPI

**Network Architecture** 

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

**Roaming** IEEE 802.11 compliant roaming between access points

Output Power<sup>3</sup> 802.11b: +17dBm minimum 802.11a: +16dBm minimum

802.11g : +16dBm minimum 802.11a : +17dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum 802.11n HT40(2.4GHz): +13dBm minimum 802.11n HT20(5GHz): +14dBm minimum 802.11n HT40(5GHz): +13dBm minimum 802.11ac VHT80(5GHz): +10dBm minimum 802.11ac VHT160(5GHz): +10dBm minimum 802.11ax HE40(2.4GHz): +12dBm minimum 802.11ax HE80(5GHz): +10dBm minimum 802.11ax HE160(5GHz): +10dBm minimum

**Power Consumption** Transmit mode 2.0 W

Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated)

Connected Standby 10mW

Radio disabled 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity<sup>4</sup>** 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac MCS0(VHT80): -84dBm maximum

802.11ac, MCS0(VHT80): -84dBm maximum 802.11ac, MCS9(VHT80): -59dBm maximum 802.11ac, MCS9(VHT160): -58.5dBm maximum 802.11ax, MCS11(HE40): -57dBm maximum 802.11ax, MCS11(HE80): -54dBm maximum 802.11ax, MCS11(HE160): -53.5dBm maximum

**Antenna type** High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

## **Technical Specifications**

**Form Factor** PCI-Express M.2 MiniCard

**Dimensions** 1. Type 2230 : 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230: 2.8q

2. Type 1216: 1.3q

**Operating Voltage** 3.3v +/- 9%

**Temperature** Operating 14° to 158° F (-10° to 70° C)

> -40° to 176° F (-40° to 80° C) Non-operating

Humidity Operating 10% to 90% (non-condensing)

> **Non-operating** 5% to 95% (non-condensing)

Altitude 0 to 10,000 ft (3,048 m) Operating

0 to 50,000 ft (15,240 m) Non-operating

**LED Activity** LED Amber - Radio OFF; LED OFF - Radio ON

### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2/5.0/5.1/5.2 Compliant

**Frequency Band** 2402 to 2480 MHz

**Number of Available** Legacy: 0~79 (1 MHz/CH)

Channels BLE: 0~39 (2 MHz/CH)

**Data Rates and** Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps **Throughput** 

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 9.5 dBm for BR and EDR.

**Power Consumption** Peak (Tx): 330 mW

Peak (Rx): 230 mW

Selective Suspend: 17 mW

**Bluetooth Software** 

Supported

Microsoft Windows Bluetooth Software

**Link Topology** 

**Power Management** Microsoft Windows ACPI, and USB Bus Support **Certifications** FCC (47 CFR) Part 15C, Section 15.247 & 15.249

ETS 300 328, ETS 300 826 **Power Management** 

Low Voltage Directive IEC950

UL, CSA, and CE Mark Certifications

**Bluetooth Profiles** 

BT4.1-ESR 5/6/7 Compliance Supported LE Link Layer Ping

LE Dual Mode

LE Link Laver

**LE Low Duty Cycle Directed Advertising** LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 -Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2

## **Technical Specifications**

Headset Profile (HSP)
Hands Free Profile (HFP)
Advanced Audio Distribution Profile (A2DP)
BT5.2
ESR9/10 Compliance
LE Advertisement Extensions
Channel Selection Algo
Limited High Duty Cycle Non-Connectable Advertising
2Mbps LE
LE Long Range

- 1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.
- 2. Check latest software/driver release for updates on supported security features.
- 3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/q (OFDM modulation).
- 5. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Require a wireless router, sold separately, that supports 80MHz and higher channels.

# Intel(R) 5G Solution 5000<sup>1</sup>

### Technology/Operating bands

WCDMA/HSPA+ operating bands:

Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL) Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)

Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)

LTE FDD/TDD operating bands:

Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)

Band 3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL)

Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)

Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)

Band 7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL) Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)

Band 12: 699 to 716 MHz (UL). 729 to 746 MHz (DL)

Dallu 12. 099 to / 10 MITZ (UL), /29 to /40 MITZ (UL)

Band 13: 777 to 787 MHz (UL), 746 to 756 MHz (DL)

Band 14: 788 to 798 MHz (UL), 758 to 768 MHz (DL)

Band 17: 704 to 716 MHz (UL), 734 to 746 MHz (DL)

Band 18: 815 to 830 MHz (UL), 860 to 875 MHz (DL)

Band 19: 830 to 845 MHz (UL), 875 to 890 MHz (DL)

Band 20: 832 to 862 MHz (UL), 791 to 821 MHz (DL)

Band 25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL)

Band 26: 814 to 849 MHz (UL), 859 to 894 MHz (DL)

Band 28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)

Band 29: 717 to 728 MHz (DL)

Band 30: 2305 to 2315 MHz (UL) 2350 to 2360 MHz (DL)

Band 32: 1452 to 1496 MHz (DL)

Band 34: 2010 to 2025 MHz (UL/DL)

Band 38: 2570 to 2620 MHz (UL/DL)

Band 39: 1880 to 1920 MHz (UL/DL)

Band 40: 2300 to 2400 MHz (UL/DL)

Band 41: 2496 to 2690 MHz (UL/DL)

Band 42: 3400 to 3600 MHZ (UL/DL)

Band 43: 3400 to 3800 MHZ (UL/DL)

Band 46: 5150 to 5925 MHZ (DL)

### **Technical Specifications**

Band 48: 3550 to 3700 MHZ (UL/DL)

Band 66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL) Band 71: 663 to 698 MHz (UL), 617 to 652 MHz (DL)

5GNR Sub 6GHZ

n1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) n2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) n3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL) n5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) n7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL) n8: 880 to 915 MHz (UL), 925 to 960 MHz (DL) n20: 832 to 862 MHz (UL), 791 to 821 MHz (DL) n25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL) n28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)

n38: 2570 to 2620 MHz (UL/DL) n40: 2300 to 2400 MHz (UL/DL) n41: 2496 to 2690 MHz (UL/DL) n48: 3550 to 3700 MHZ (UL/DL)

n66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL) n71: 663 to 698 MHz (UL), 617 to 652 MHz (DL)

n77: 3300 to 4200 MHz (UL/DL) n78: 3300 to 3800 MHz (UL/DL) n79: 4400 to 5000 MHz (UL/DL)

Wireless protocol standards

5GNR Air Interface 3GPP Rel15 5G NR sub-6

LTE Rel14

20 layers and 2 Gbps downlink (DL) throughput - 4 × 4 MIMO across 5x

CA

200 Mbps/uplink (UL) throughput - 40 MHz ULCA and 256 QAM

WCDMA R99,

3GPP Release 5, 6, 7 and 8 UMTS Specification

GPS Standalone, A-GPS (MS-A, MS-B)

**GPS bands** GPS: L1 (1575.42MHz)

GLONASS: L1 (1602MHz) BeidouB1(1561.098MHz) Galileo E1 (1575.42) QZSS(1575.42 MHz)

**Maximum data rates** SA 5G/NR sub-6 Peak: DL4.67Gbps/ UL 1.25Gbps

5G NSA sub 6G: DL: 3.8 Gbps/UL 700Mbps LTE: ue-CategoryDL 19, (DL: 1.6 Gbps) ue-CategoryUL 13, (UL: 150Mbps)

DC-HSPA+: 42 Mbps (Download), 11.5 Mbps (Upload)

Maximum output power LTE: 23 dBm in all band except B41

LTE B41 HPUE = 26dBm

NR: 23 dBm in all band except n41, n77, n78 and n79

LTE n41, n77, n78 and n79 HPUE = 26dBm

HSPA+: 23.5 dBm

**Maximum power consumption** 5G Sub 6 : 2500 mA

LTE: 1,300 mA (peak); 1100 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 8 g

**Dimensions** 52 mm × 30 mm × 2.6 mm

(Length x Width x Thickness)

### **Technical Specifications**

1. Intel 5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. Backwards compatible to 4G LTE and 3G HSPA technologies. 51 module planned to be available in select platforms and select countries, where carrier supported.

Intel® XMM<sup>TM</sup> 7560 R+ LTE-Advanced Pro<sup>1</sup> Technology/Operating bands

FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3),

1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30),

1700/2100 (Band 66), 600 (band 71).

TDD LTE: 2100 (Band 34), 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41), 3500 (Band 42), 3700 (Band 43), 3700 (band 48), 5200

(Band 46 RX only) MHz;

HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4),

850 (Band 5), 900 (Band 8) MHz

Wireless protocol standards 3GPP Release 12 LTE Specification DL-CAT.16, DL 100MHz BW throughput

up to 978Mbps; UL-CAT.13 40MHz throughput up to 150Mbps WCDMA R99. 3GPP Release 5. 6. 7 and 8 UMTS Specification

Standalone GPS/Beidou/Glonass, A-GPS (MS-A, MS-B)

GPS bands

GPS

1575.42 MHz ± 1.023 MHz. GLONASS 1596-1607MHz. Beidou 1561.098

MHz

Maximum data rates

LTE: 978 Mbps (Download), 150 Mbps (Upload)
DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload)
HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)

Maximum output power

LTE: 23 dBm in all band except B41

LTE B41 HPUE = 26dBm HSPA+: 23.5 dBm

Maximum power LTE: 1,200

consumption

LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 6 q

Dimensions (Length x Width x

(Length x wid Thickness) 42 x 30 x 2.3 mm

eSIM Support

1. Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available ir all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

### **Technical Specifications**

Near Field Communications Controller (optional) Dimensions (L x W x H)

Module 25 mm by 10 mm by 2.0 mm

Chipset

NPC100

System interface

I2C

**NFC RF standards** 

ISO/IEC 14443 A ISO/IEC 14443 B

ISO/IEC 15693 ISO/IEC 18092

ECMA-340 NFCIP-1 Target and Initiator

ECMA-320 NFCIP-2

NFC Forum Support

Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2

Reader (PCD-VCD)

Mode (1)

ISO/IEC 14443 A ISO/IEC 14443 B

ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire

FeliCa

Jewel and Topaz cards

Card Emulation (PICC-VICC) Mode (1) ISO/IEC 14443 A

ISO/IEC 14443 B and B' MIFARE

FeliCa

Frequency 13.56 MHz

NFC Modes Supported Reader/Writer, Peer-to-Peer Raw RF Data Rates 106, 212, 424, 848 kbps

Operating temperature 0°C to 70°C

Storage temperature -20°C to 125°C

Humidity 10-90% operating 5-95% non-operating

Supply Operating voltage 4.35 to 5.25 Volts

**I/O Voltage** 1.8V or 3.3V

**Power Consumption** 

(Booster enable, VBAT= 3.3V, VCC\_BOOST = 5V)

**Mode** Power Consumption, Typical

Polling 7.3 mA

Detected Test Tag Type 1 Total 283.8 mA

Net Module 236.8 mA

Detected Test Tag Type 2 Total 288.8 mA

Net Module 241.8 mA

Detected Test Tag Type 3 Total 287.7 mA

Net Module 240.7 mA

Detected Test Tag Type 4 Total 282.3 mA

Net Module 235.3 mA

Antenna Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna matching is

external to module.

### **POWER**

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time. usage. environment. temperature. system configuration. loaded apps. features. power management settings and other factors

## **Technical Specifications**

AC Adapter 45 Watt nPFC Standard USB type C Straight 1.8m Dimensions (H x W x D)

Weight Input

**Output** 

94.0mm x 40.0mm x 26.5mm

192.5g +/-10%

**Input Efficiency** Average Efficiency of 25%, 50%, 75%, 100%

load condition with 115Vac/230Vac Spec:

5V:81.5% 9V:86.7% 12V:87.41% 15V:87.8%

**Input frequency range** 47 ~ 63Hz

**Input AC current** Max. 1.4 A at 90 Vac

Output power 5V/15W

9V/27W 12V/36W 15V/45W

**DC output** 5V/9V/12V/15V **Hold-up time** 5ms at 115 Vac input

Output current limit <5.0A

**Connector** C6

**Environmental Design** Operating 32°F to 95°F (0° to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20° to 85°C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications

Ly.

ifications \*CE Mark - full compliance with LVD and EMC directives

\* Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1

and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1, SELV;

Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class

B, CISPR32 Class B, CCC, NOM-001 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient condition.

### **Technical Specifications**

AC Adapter 65 Watt nPFC Slim USB type C Straight 1.8m **Dimensions (H x W x D)** 88x53.5x21mm **Weight** unit: 220q +/- 10q

Input Efficiency

86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A

81.5% min at 115 Vac/ 230Vac @ 5V/3A

**Input frequency range** 47 ~ 63 Hz

**Input AC current** 1.6 A at 90 VAC and maximum load

Output Output power 65W

**DC output** 5V/9V/12V/15V/20V **Hold-up time** 5ms at 115 Vac input

Output current limit <8.0A

**Connector** C6

**Environmental Design** Operating 32°F to 95°F (0° to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20° to 85°C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 5% to 95% **Storage Humidity** 5% to 95%

EMI and Safety E

**Certifications** \*CE Mark - full compliance with LVD and EMC directives

\* Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1

and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1, SELV;

Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class

B, CISPR32 Class B, CCC, NOM-001 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 65 Watt nPFC Standard USB type C Straight 1.8m Dimensions (H x W x D)

Weight

Input

**Output** 

90.0mm x 51.0mm x 28.5mm

250g +/-10%

**Input Efficiency** Average Efficiency of 25%, 50%, 75%, 100%

load condition with 115Vac/230Vac Spec:

5V: 81.5% 9V: 86.7% 12V: 88% 15V: 88% 20V: 89%

**Input frequency range** 47 ~ 63Hz

**Input AC current** Max. 1.6 A at 90 Vac

**Output power** 5V/15W 9V/27W

12V/60W 15V/60W 20V/65W

**DC output** 5V/9V/12V/15V/20V **Hold-up time** 5ms at 115 Vac input

Output current limit <8.0A

**Connector** C6

### **Technical Specifications**

**Environmental Design** Operating 32°F to 95°F (0° to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20° to 85°C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

**EMI and Safety** Eg

**Certifications** \*CE Mark - full compliance with LVD and EMC directives

\* Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1

and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1, SELV;

Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class

B, CISPR32 Class B, CCC, NOM-001 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient condition.

HP 3-cell Long Life Li-Ion

(38Wh)<sup>1</sup>

Dimensions (H x W x D)

251.8 x 66.1 x 6.82mm (9.91 x 2.6 x 0.27 inch)

Weight 0.184kg +/- 10g(0.406lb)

Cells/Type3cell Lithium-Ion Polymer cell / 564975EnergyVoltage11.58V

Amp-hour capacity 3.283Ah

Watt-hour capacity<sup>1</sup> 38Wh

**Temperature Operating (Charging)** 32° to 113° F (0° to 45° C)

**Operating (Discharging)** 14° to 140° F (-10° to 60° C)

No

Fuel Gauge LED NA

Warranty Follow product spec

Optional Travel Battery

**Available** 

HP 3-cell Long Life Li-Ion

(51 Wh) <sup>1</sup>

Dimensions (H x W x D)

251.8 x 70.3 x 6.82mm (9.91 x 2.77 x 0.27 inch)

**Weight** 0.229kg +/- 10g (0.505 lb)

Cells/Type 3cell Lithium-Ion Polymer cell / 566075

**Energy Voltage** 11.58V

Amp-hour capacity 4.431Ah

Watt-hour capacity<sup>1</sup> 51.3Wh

**Temperature Operating (Charging)** 32° to 113° F (0° to 45° C)

**Operating (Discharging)** 14° to 140° F (-10° to 60° C)

Fuel Gauge LED NA

Warranty Follow product spec

Optional Travel Battery No

vailable

Available

### **AUDIO**

**Technical Specifications** 

**HD Stereo Codec** Realtek ALC3315

**Audio I/O Ports** Headset: CTIA only and Headphone-out

Internal Speaker Amplifier Cirrus Logic High-Efficiency Boosted Class D Amplifier

**Multi-streaming Capable** Playback multi-streaming can be enabled in the audio control panel to allow

independent audio. Following MSFT Behaviour

DAC: 44.1k/48kHz

ADC: 48kHz

**Wavetable Syntheses** 

Sampling

**Analog Audio** Support 3.5mm Headset: CTIA only and Headphone-out

260 uA

# of Channels on Line-Out

**Internal Speaker** Yes

FINGERPRINT READER

**Sensor vendor** Synaptics FS7604 Capacitive Sensor type

363DPI **DPI** resolution

7.4x6mm sensor area Scan area

<1% **False Rejection Rate** 

1:50K FAR **False Acceptance Rate Mobile Voltage Operation** 3.0V to 3.6V 0~60°C **Operating Temperature** 100mA Max **Current Consumption Image** 

**Low Latency Wait For Finger** 

**Capture Rate** <30msec per image

IEC 61000-4-2 4B (+/-15KV) **ESD Resistance** 363 dpi / 7.4x6mm sensor area **Detection Matrix** 

**Specifications** 

<u>ENVIRUNMENTAL DATA</u>	
Eco-Label Certifications &	This product has received or is in the process of being certified to the following approvals and may be
declarations	labeled with one or more of these marks:
	IT ECO declaration
	US ENERGY STAR®
	US Federal Energy Management Program (FEMP)
	<ul> <li>EPEAT? Gold registered in the United States. See http://www.epeat.net for registration status in your country.</li> </ul>
	• TCO Certified
	China Energy Conservation Program (CECP)
	China State Environmental Protection Administration (SEPA)
	Taiwan Green Mark
	Korea Eco-label
	Japan PC Green label*
Sustainable Impact	Ocean-bound plastic in Speaker

Outside Box and corrugated cushions are 100% sustainably sourced and

Molded Paper Pulp Cushion inside box is 100% sustainably sourced and

• 60% post-consumer recycled plastic

Low halogen

recyclable

# **Technical Specifications**

	recyclable	voilable			
System Configuration	Bulk packaging av The configuration used for Notebook model is based or	the Energy Consumption a	sumption and Declared Noise Emissions data for the onfigured Notebook"?.		
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz		
Normal Operation (Sort idle)	5.88 W	6.17 W	5.92 W		
Normal Operation (Long		••••			
idle)	1.66 W	1.85 W	1.76 W		
Sleep	1.66 W	1.85 W	1.76 W		
Off	0.46 W	0.48 W	0.41 W		
	does not offer ENERGY STAI typically configured PC feat Windows® operating syster	R® compliant configuration curing a hard disk drive, a h m.	Specifications for computers. If a model factorists, then energy efficiency data listed is for a light efficiency power supply, and a Microsoft		
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz		
Normal Operation (Short idle)	20.1 BTU/hr	21.1 BTU/hr	20.2 BTU/hr		
Normal Operation (Long	20.1 610/11	21.1 010/111	20.2 810/111		
dle)	5.7 BTU/hr	6.3 BTU/hr	6 BTU/hr		
Sleep	5.7 BTU/hr	6.3 BTU/hr	6 BTU/hr		
Off	1.6 BTU/hr	1.6 BTU/hr	1.4 BTU/hr		
	*NOTE: Heat dissipation is contact attained for one hour.	alculated based on the mea	asured watts, assuming the service level is		
Declared Noise Emissions	Sound Power		Sound Pressure		
(in accordance with	(L <sub>WAd</sub> , bels)		(L <sub>pAm</sub> , decibels)		
ISO 7779 and ISO 9296)	With		(Тарапі) ассіосізу		
Typically Configured - Idle	2.9		21.6		
Fixed Disk - Random writes	3.6		28.5		
Optical Drive - Sequential	4.1		33.2		
reads Longevity and Upgrading	This product can be upgra Upgradeable features and		ts useful life by several years.		
Additional Information	<ul> <li>Spare parts are available throughout the warranty period and or for up to "5"? years after the end of production.</li> <li>This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.</li> <li>This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.</li> <li>This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).</li> <li>This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net</li> </ul>				

# **Technical Specifications**

	and IS	cs parts weighing over 25 grams used in the psolon and the psolon and the psolon are seen in the psolon are seen as properly conduct is 95.4% recycle-able when properly conduct is 95.4% recycle-able when properly conduct	,
Packaging Materials	External:	PAPER/Corrugated	269 g
		PAPER/Paper	3 g
		PAPER/Molded Pulp	108 g
	Internal:	PLASTIC/Polyethylene low density - LDPE	-
	The plastic	packaging material contains at least 0.0% re	
RoHS Compliance	extend the r (RoHS) Directly development.  We believe wide eliminal substances pertains to extend the evolve.	replies fully with materials regulations. We were estrictions in the European Union (EU) Restrictive to our products worldwide through the Fat of related legislation in Europe, as well as Countries the RoHS directive and similar laws play an ination of substances of concern. We have supprincluding PVC, BFRs, and certain phthalates electrical and electronics products.  I voluntary objective to achieve worldwide comes for virtually all relevant products by July 2018 accommitment to include further restricted subscriptions.	iction of Hazardous Substances HP GSE. HP has contributed to the China, India, and Vietnam.  Important role in promoting industry- corted the inclusion of additional c-in future RoHS legislation that  Inpliance with the new EU RoHS Is, and we will continue to extend the costances as regulations continue to
Material Usage	the HP Gene http://www. gen_specific	n Azo Colorants n Brominated Flame Retardants - may not be us um nated Hydrocarbons nated Paraffins Ethylhexyl) phthalate (DEHP) l butyl phthalate (BBP) vl phthalate (DBP) utyl phthalate (DIBP)	'supplychain/
	<ul> <li>Halog</li> <li>Lead c</li> <li>Lead a</li> <li>Mercu</li> <li>Nickel</li> <li>carrie</li> <li>Ozone</li> <li>Polybi</li> </ul>	eldehyde enated Diphenyl Methanes arbonates and sulfates and Lead compounds ric Oxide Batteries - finishes must not be used on the external surf d by the user. Depleting Substances cominated Biphenyls (PBBs) cominated Biphenyl Ethers (PBBEs)	face designed to be frequently handled o

Polyvinyl Chloride (PVC) - except for wires and cables, and certain retail packaging has been

Polybrominated Biphenyl Oxides (PBBOs)

voluntarily removed from most applications.

Polychlorinated Biphenyl (PCB)
Polychlorinated Terphenyls (PCT)

<b>Technical Specifications</b>	
	<ul> <li>Radioactive Substances</li> <li>Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)</li> </ul>
Packaging Usage	HP follows these guidelines to decrease the environmental impact of product packaging:
	<ul> <li>Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.</li> <li>Eliminate the use of ozone-depleting substances (ODS) in packaging materials.</li> <li>Design packaging materials for ease of disassembly.</li> <li>Maximize the use of post-consumer recycled content materials in packaging materials.</li> <li>Use readily recyclable packaging materials such as paper and corrugated materials.</li> <li>Reduce size and weight of packages to improve transportation fuel efficiency.</li> <li>Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.</li> </ul>
End-of-life Management and Recycling	HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a> . These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
HP, Inc. Corporate	For more information about HP's commitment to the environment:
Environmental Information	Global Citizenship Report
	http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
	Eco-label certifications
	http://www8.hp.com/us/en/hp-information/environment/ecolabels.html
	ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and
footnotes	<ul> <li>http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf</li> <li>Percentage of ocean-bound plastic contained in each component varies by product</li> </ul>
Toothotes	<ul> <li>Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard.</li> <li>External power supplies, WWAN modules, power cords, cables and peripherals</li> </ul>
	<ul> <li>excluded.</li> <li>100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers.</li> </ul>
	Fiber cushions made from 100% recycled wood fiber and organic materials.

## **COUNTRY OF ORIGIN**

China

Options and Accessories (Sold separately and availability may vary by country)

**DOCKING (Sold Separately)** 

Docking station model #1 Total number of supported displays

(incl.the notebook display)

Max.resolutions supported Dual 4K @30Hz or dual 4K UHD @ 60Hz is supported

4

Single 8K@ 30Hz (multiple tiles) for Thunderbolt hosts

Non-TBT hosts DP 1.4 in high res mode (1) 8K video single cable@30Hz [10]

**Dock Connectors** 2xDP, 1xVGA, 1xTB, 1xUSB-C alt-mode

**Technical limitations** Thunderbolt Hosts:

Maximum of (4) displays with maximum resolution of 5K@ 30Hz running

Thunderbolt host.

Max resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or

running a non-Thunderbolt host in High Resolution mode @30Hz

Non-Thunderbolt hosts:

**HP Thunderbolt Dock G2** 

The highest resolution for dual displays running a non-Thunderbolt host in multi-

function mode is

(1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port

Non-Thunderbolt hosts support (3) displays with a max resolution of: (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1)

4K UHD @ 30Hz.

**Docking station model #2** 

Total number of supported displays

(incl.the notebook display)

Max.resolutions supported

**Dock Connectors** 

HP USB-C Dock G5

Dual 5K@ 30Hz + (1) 4K UHD (multi-function mode) [10]

1xHDMI. 2xDP

**Technical limitations** Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution

mode.

3

Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K

UHD@ 30 Hz on HDMI in multi-function mode

The highest resolution for a non-Thunderbolt host in Multi-function mode is a

single 5K dual cable (using both DP ports) + (1) 4K on HDMI port.

**Docking station model #3** 

Total number of supported displays

(incl.the notebook display)

Max.resolutions supported

**Dock Connectors** 

HP USB-C/A Universal Dock G2

Triple 4K UHD@ 60Hz [10]

1xHDMI. 2xDP

**Technical limitations** The best resolution for dual or triple displays is 4K UHD@ 60Hz.

> For use with the USB-A adapter that comes in the box the maximum number of displays supported is (2) 4k x 60 Hz on the Type-A Gen 1 connection from the

host

Туре	Description	Part Number
Audio/Video	HP Wired USB-A Stereo Headset	428K6AA
	HP Wired 3.5mm Stereo Headset	428K7AA
Cases	HP Executive 15.6 Backpack	6KD07AA
	HP Executive 15.6 Top Load	6KD06AA
	HP Executive Slim 14.1 Top Load	6KD04AA
	HP Prelude G2 15.6 Backpack	1E7D6AA
	HP Prelude G2 15.6 Top Load	1E7D7AA

Options and Accessories	(Sold separately	v and availahility	<i>ı</i> mav varv	<i>i</i> hy country)
	(Jola Jepai atel	y uniu uvuntubitit	, iiiay vai y	y by country /

options and nece	somes (Sold Separately and availability may vary by country)	
	HP Prelude Pro Recycled 15.6 Backpack	1X644AA
	HP Prelude Pro Recycled 15.6 Top Load	1X645AA
	HP Renew 14 Laptop Sleeve	2E6U9AA,2E6V0AA
	HP Renew Business 14.1 Laptop Bag	3E5F9AA
	HP Renew Business 14.1 Laptop Sleeve	3E2U7AA
	HP Renew Business 17.3 Laptop Backpack	3E2U5AA
	HP Renew Business 17.3 Laptop Bag	3E2U6AA
	HP Renew Business 15.6 Laptop Bag	3E5F8AA
Docking	HP Thunderbolt 120W G2 Dock (Hook)	2UK37AA
	HP Thunderbolt 120W G2 Dock w/Audio (HOOK+MIXMASTER)	3YE87AA
	HP Thunderbolt 230W G2 Dock w/Combo Cable (Hook)	3TR87AA
	HP USB-C 120W G5 Dock (AdicoraA)	5TW10AA
	HP USB-C/A 120W G2 Universal Dock (Adicora-D)	5TW13AA
Hub	HP USB-C Mini Dock	1PM64AA
	HP Universal USB-C Multiport Hub	50H55AA
	HP USB-C Travel Dock G2	7PJ38AA
	HP USB-C to USB-A Hub	Z6A00AA
Adapter	HP HDMI to DVI Adapter	F5A28AA
	HP HDMI to VGA Adapter	H4F02AA
	HP USB to Gigabit RJ45 Adapter	N7P47AA
	HP USB-C to DisplayPort Adapter	N9K78AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to RJ45 Adapter	V7W66AA
	HP USB-C to USB 3.0 Adapter	N2Z63AA
	HP USB-C to VGA Adapter	N9K76AA
	HP USB-C to RJ45 Adapter G2	4Z527AA
	HP USB 3.0 to Gigabit RJ45 Adapter G2	4Z7Z7AA
Keyboard/Combo	HP 975 USB+BT Dual-Mode Wireless Keyboard	3Z726AA
	HP 455 Programmable Wireless Keyboard	4R177AA
	HP 125 WD USB Keyboard	266C9AA
	HP 320K WD USB Keyboard	9SR37AA
	HP 655 Wireless Keyboard and Mouse Combo	4R009AA
	HP 225 Wired Mouse and Keyboard Combo	286J4AA
	HP 235 Wireless Mouse and Keyboard Combo	1Y4D0AA
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
Mouse	HP USB Premium Wireless Mouse	1JR31AA
	HP 435 Multi-Device Wireless Mouse	3B4Q5AA
	HP 125 USB-A Wired Mouse	265A9AA

# Options and Accessories (Sold separately and availability may vary by country)

options and At	cessories (Sold separately and availability may vary by country)	
	HP 128 USB Laser Wired Mouse	265D9AA
	HP 320M USB-A Wired Mouse	9VA80AA
	HP Creator USB-A+Bluetooth 935 Wireless Mouse Black	1D0K8AA
	HP USB-A+Bluetooth Multi-Device 635 Wireless Mouse Black	1D0K2AA
	HP USB-A+Bluetooth Travel Bluetooth Mouse	6SP30AA
Power	HP 65W USB-C Auto Chevy AC Power Adapter	5TQ76AA
	HP 45W USB-C G2 Zeus AC Power Adapter	1HE07AA
	HP 45W USB-C LC Dali AC Power Adapter	1MZ01AA
	HP 65W USB-C Hades AC Power Adapter	1HE08AA
	HP 65W USB-C LC AC Power Adapter	1P3K6AA
	HP 65W USB-C Travel Slim Kermit AC Power Adapter	3PN48AA
Commodity	HP USB DVD-Writer EXT ODD	F2B56AA
	HP Nano Keyed Cable Lock	1AJ39AA
	HP Nano Master Keyed Cable Lock	1AJ40AA
	HP SureKey Standard/Nano/Wedge Cable Lock	6UW42AA

## Change Log

Date of change:	Version History:	Description of change:
	V1 to V2	

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